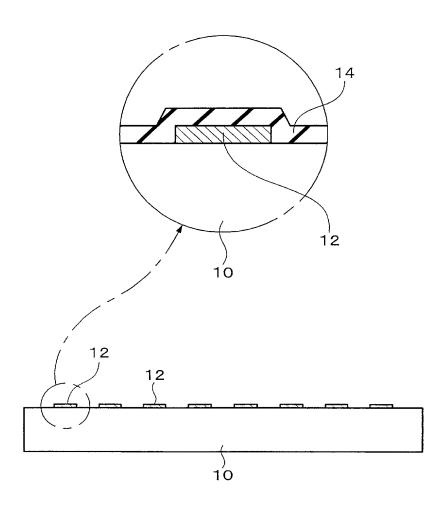
Title: METHOD FOR FORMING A BUMP, SEMICONDUCTOR DEVICE AND METHOD OF FABRICATING SAME, SEMICONDUCTOR CHIP, CIRCUIT BOARD, AND ELECTRONIC INSTRUMENTAL OF THE PROPERTY OF THE PROPERTY OF THE PROPERTY OF THE PROPERTY OF T

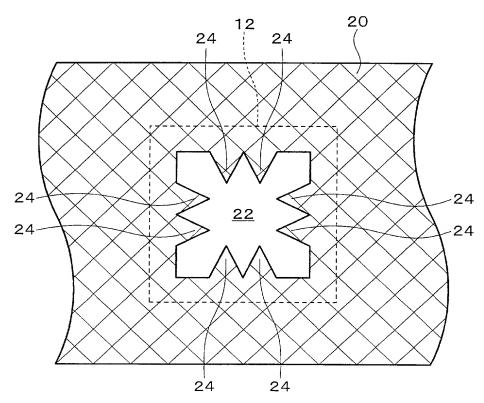
Inventor: Fumiaki MATSUSHIMA Atty. Ref. No.: 9319I-000277 1/13

FIG. 1



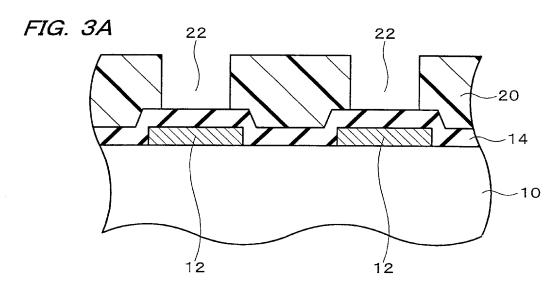
Inventor: Fumiaki MATSUSHIMA Atty. Ref. No.: 9319I-000277 **2/13**

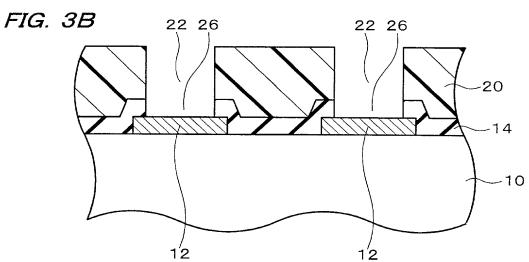
FIG. 2

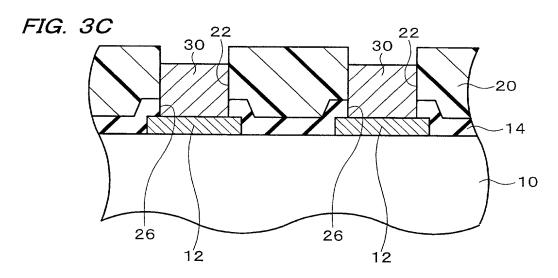


Inventor: Fumiaki MATSUSHIMA Atty. Ref. No.: 9319I-000277 **3/13**

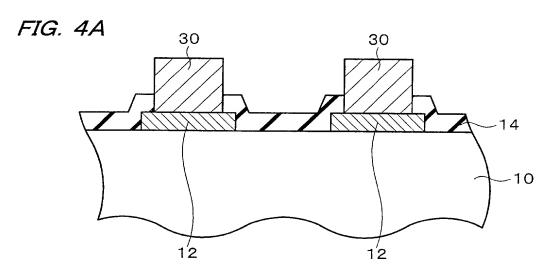
3

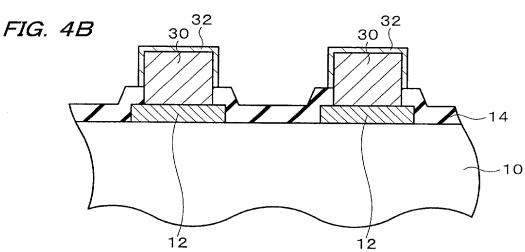


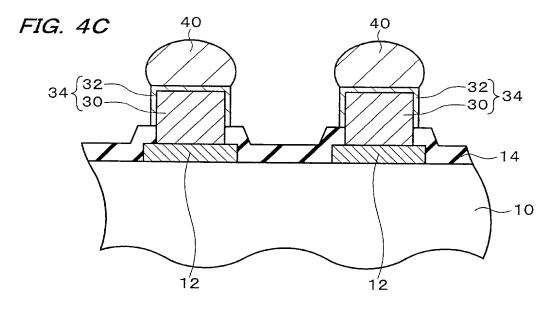




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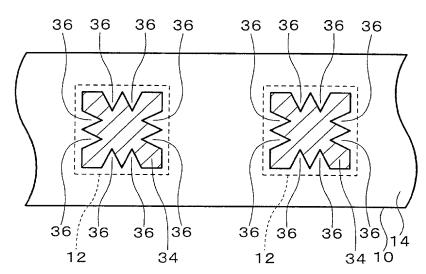






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FIG. 5



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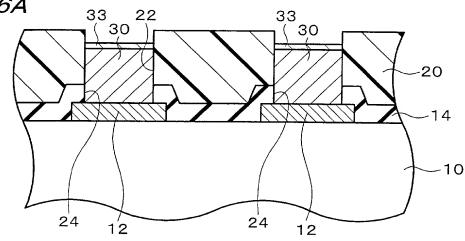
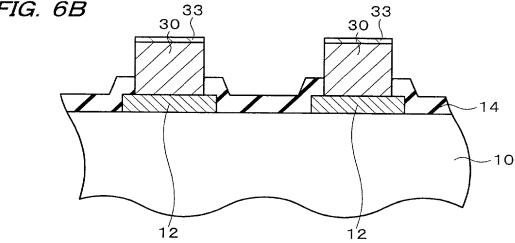
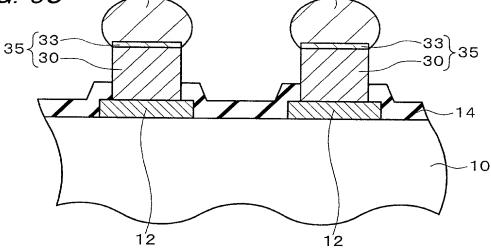


FIG. 6B



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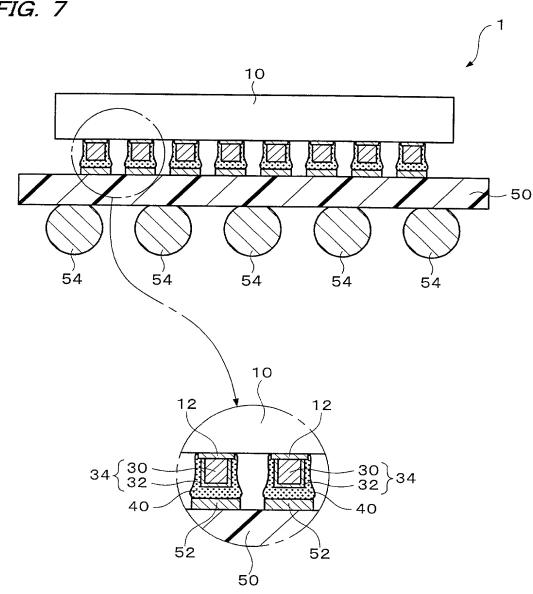
FIG. 6C



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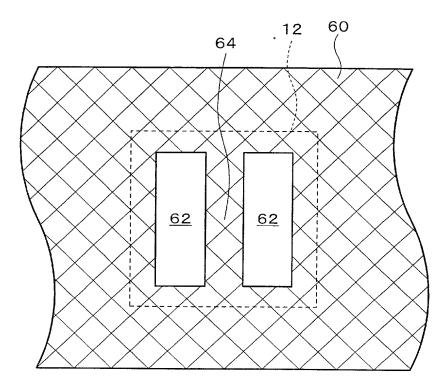
Inventor: Fumiaki MATSUSHIMA Atty. Ref. No.: 9319I-000277 **7/13**

FIG. 7

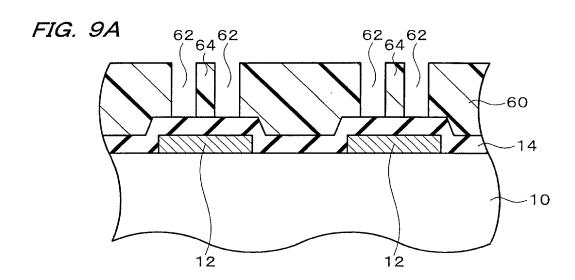


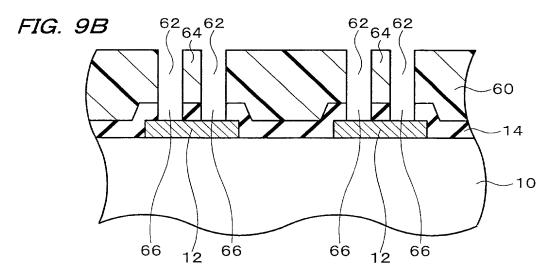
Inventor: Fumiaki MATSUSHIMA Atty. Ref. No.: 9319I-000277 **8/13**

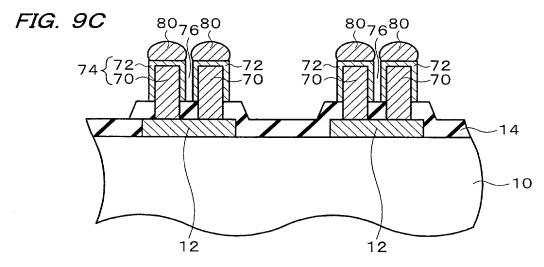
FIG. 8



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FIG. 10

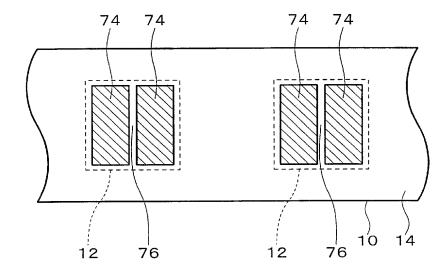
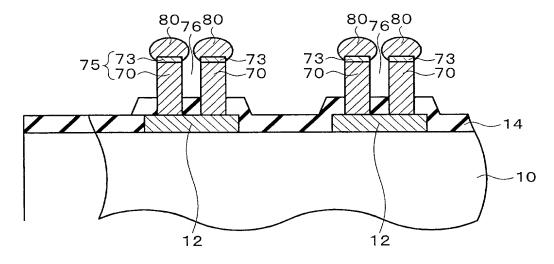


FIG. 11



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FIG. 12A

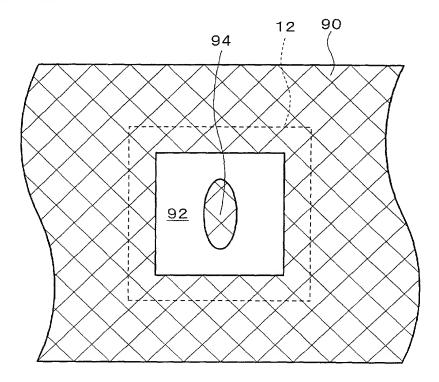
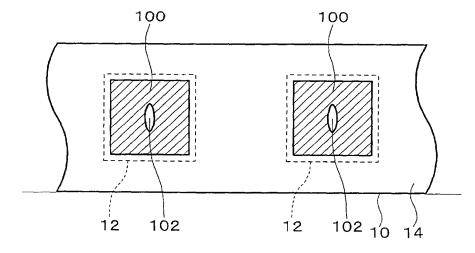
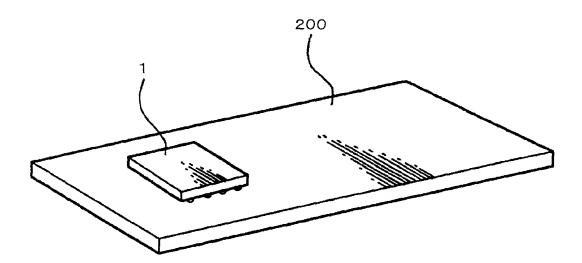


FIG. 12B



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FIG. 13



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FIG. 14

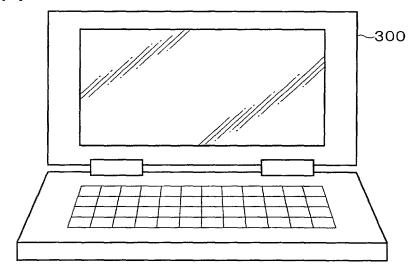


FIG. 15

